

Small Signal Diode



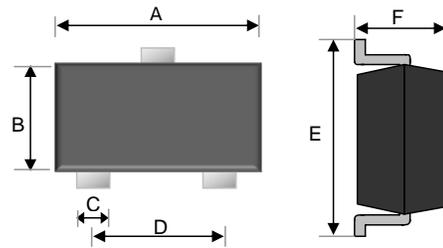
Features

- ◇ Low reverse current high reliability
- ◇ Surface device type mounting
- ◇ Moisture sensitivity level 1
- ◇ Matte tin (Sn) lead finish with Nickel (Ni) underplate
- ◇ Pb-free version and RoHS compliant
- ◇ Green compound (Halogen free) with suffix "G" on packing code and prefix "G" on date code.

Mechanical Data

- ◇ Case : SOT- 323 small outline plastic package
- ◇ Terminal: Matte tin plated, lead free, solderable per MIL-STD-202, Method 208 guaranteed
- ◇ High temperature soldering guaranteed: 260°C/10s
- ◇ Weight: 5±0.5mg
- ◇ Marking:ZA

SOT-323

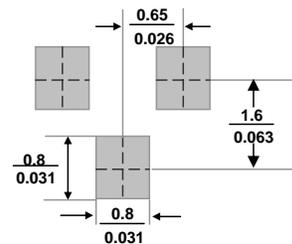


Dimensions	Unit (mm)		Unit (inch)	
	Min	Max	Min	Max
A	1.90	2.10	0.075	0.083
B	1.15	1.35	0.045	0.053
C	0.25	0.35	0.010	0.014
D	1.20	1.40	0.047	0.055
E	2.00	2.20	0.079	0.087
F	0.80	1.00	0.031	0.039

Ordering Information

Part No.	Packing Code	Package	Packing	Marking
RB706F-40	SOT-323	RF	3K / 7" Reel	ZA
RB706F-40	SOT-323	RFG	3K / 7" Reel	ZA

Suggested PAD Layout



Maximum Ratings

Rating at 25°C ambient temperature unless otherwise specified.

Maximum Ratings

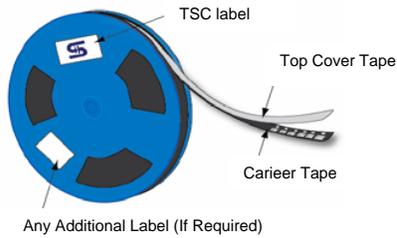
Type Number	Symbol	Value	Units
Repetitive Peak Reverse Voltage	V_{RRM}	45	V
Reverse Voltage	V_R	40	V
Mean Forward Current	I_o	30	mA
Non-Repetitive Peak Forward Surge Current ($t=8.3ms$)	I_{FSM}	0.2	A
Junction Temperature	T_J	125	°C
Storage Temperature Range	T_{STG}	-55 ~ +125	°C

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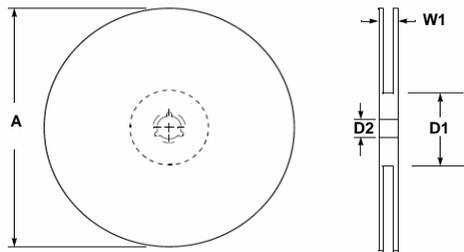
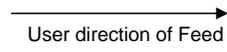
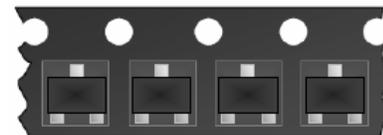
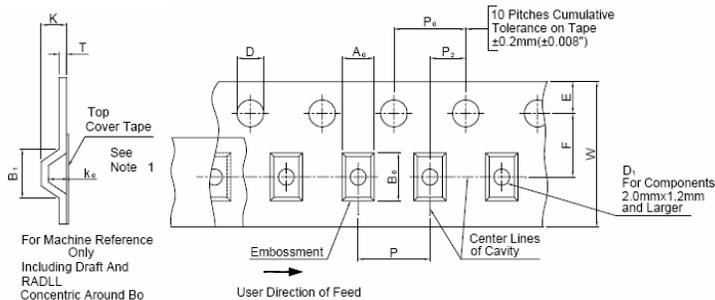
Electrical Characteristics

Type Number		Symbol	Min	Max	Units
Reverse Breakdown Voltage	$I_R = 10\mu A$	$V_{(BR)}$	45	-	V
Forward Voltage	$I_F = 1mA$	V_F	-	0.37	V
Reverse Leakage Current	$V_R = 10V$	I_R	-	1	μA
Junction Capacitance	$V_R = 1V, f = 1.0MHz$	C_J	-	2.0	pF

Carrier & Reel specification



Item	Symbol	Dimension(mm)
Carrier depth	K	2.40 Max.
Sprocket hole	D	1.50 ±0.10
Reel outside diameter	A	178 ± 1
Reel inner diameter	D1	50 Min.
Feed hole width	D2	13.0 ± 0.5
Sprocket hole position	E	1.75 ±0.10
Punch hole position	F	3.50 ±0.05
Sprocket hole pitch	P0	4.00 ±0.10
Embossment center	P1	2.00 ±0.10
Overall tape thickness	T	0.6 Max.
Tape width	W	8.30 Max.
Reel width	W1	14.4 Max.



Note 1: A0, B0, and K0 are determined by component size. The clearance between the components and the cavity must be within 0.05 mm min. to 0.5 mm max. The component cannot rotate more than 10° within the determined cavity.

Note 2: If B1 exceeds 4.2 mm(0.165") for 8 mm embossed tape, the tape may not feed through all tape feeders.

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Rating and Characteristic Curves

